

**Data issued: July 7, 2021**  
**Valid period: 12 months**

## Bulletin

We, CHIMEI CORPORATION, to the best of our knowledge hereby certify that the resins listed below (hereinafter referred as "products") as directly manufactured by us

POLYLAC® ABS (J01)	PA-704LRP, PA-705, PA-707, PA-709, PA-709H, PA-709K, PA-709P, PA-709S, PA-716, PA-717C, PA-718, PA-726, PA-726M, PA-727, PA-737, PA-737 A03, PA-746, PA-746H, PA-746M, PA-746Y, PA-747, PA-747F, PA-747H, PA-747R, PA-747S, PA-747S A01, PA-749, PA-749S, PA-756, PA-756S, PA-756H, PA-757, PA-757 A01, PA-757 AB, PA-757F, PA-757G J08, PA-757H, PA-757N, PA-757K, PA-777B, PA-777C, PA-777D, PA-777E, PA-77NB, PA-797, PA-797S (J01) - The suffix may be used to denote the black color grade manufactured from Chi Mei Corp. (A01 & A03) - The suffix may be used to denote the white color grade manufactured from Chi Mei Corp.
POLYLAC® MABS	PA-703TRP, PA-758, PA-758R, LS-L230
KIBISAN® SAN	PN-106, PN-107, PN-117, PN-117C, PN-117H, PN-127, PN-127H, PN-137H, PN-106 L150 FG, PN-107 L125 FG, PN-117 L200 FG, PN-127 L150 FG
POLYREX® PS	PG-22, PG-33, PG-80, PG-80N, PG-383, PG-383D, PH-55Y, PH-60, PH-88, PH-88S, PH-888G, PH-888H, PH-88SF
ACRYREX® PMMA	CM-203, CM-205, CM-205G, CM-205N, CM-207, CM-207G, CM-211, CM-211G
ACRYSTEX® SMMA	PM-500, PM-500G, PM-600, PM-700G
KIBITON® TPE	PB-511, PB-575, PB-585, PB-587, PB-5300, PB-5301, PB-5302, PB-5308, PB-5502
KIBITON® Q-resin	PB-5630, PB-5900, PB-5903, PB-5906, PB-5910, PB-5925
KIBIPOL® LBR/SSBR/HBR	PR-040, PR-040C, PR-040G, PR-040S, PR-050, PR-060S, PR-245, PR-255, PR-303, PR-1205
ACRYPOLY®	CM-205B, CM-205X, PM-500X, LM-700X

The above statement is based on our current level of knowledge and covers the above products directly manufactured and supplied by CHIMEI CORPORATION at the date of issue. CHIMEI CORPORATION makes no warranties, whether express or implied, and assumes no liability in connection with any use of above information. Notwithstanding the foregoing, CHIMEI CORPORATION shall in no event be held obligated or liable for any claims due to or arising from (i) any customer provided, consigned, materials and/or parts, which are incorporated or adopted in the products; (ii) any combination of the products with material not provided or authorized by our company; (iii) any modifications to the products which are made or directed by customer; (iv) our compliance with the specifications, instructions, and/or designs provided by customer; (v) any anti-trust, unfair competition and/or other unlawful actions effected by customer; or (vi) any defects, infringement, breach and/or violation which are arising out of customer's faults or otherwise not solely and directly attributable to CHIMEI CORPORATION. In no event will CHIMEI CORPORATION be liable for any indirect, special, exemplary, punitive, or consequential damages (including lost profits) of any nature whatsoever whether arising out of the purchase, shipment, unloading, handling, or use of any product or otherwise.





## KIBILITE®

DC-552F, DC-552G, DC-553F, DC-603F, DM-000B, DM-551M,  
DM-553B, DM-601M, DM-601R, DS-551A, DS-553A, DS-553C,  
DS-553H, DS-601S, DS-601Y, DS-603A, DS-603C, DS-653A,  
DS-653C, DS-743B, DS-753B, DS-903A, DS-903E, DS-903H,  
DS-943A, DS-943B, DS-943G, DS-943H, DS-943I, DS-963E,  
DS-963G

## KIBILAC®

PW-957, PW-978B, PW-997, PW-997G, PW-997S

contain no following substances.

1. Halogen (F, Br, I) and its compounds
2. Halogen (Cl)
3. PBDEs (Polybrominated Diphenyl Ethers)
4. PBBs (Polybrominated Biphenyls)
5. Ozone Depleting Chemicals (CFCs & HCFCs)
6. Chlorinated Paraffin (C10-C13)
7. Polyvinyl Chloride (PVC)
8. Mercury (Hg) and its compounds
9. Lead (Pb) and its compounds
10. Cadmium (Cd) and its compounds
11. Chromium (Cr) and its compounds
12. Arsenic (As) and its compounds
13. Antimony (Sb) and its compounds
14. Selenium (Se) and its compounds
15. Barium (Ba) and its compounds
16. Beryllium (Be) and its compounds
17. Bismuth (Bi) and its compounds
18. Organic tin compounds (TBT, TPT, DOT, DBT)
19. Polychlorinated Biphenyls (PCBs) and Terphenyls (PCTs) and Naphtalenes (PCNs)
20. Poly naphthalenes
21. Azo colorants (according to REACH-ANNEX-XVII-APPENDIX 8)
22. Asbestos
23. Phthalates
24. APEO: Including Alkylphenol(AP), Octylphenol(OP), Nonylphenol(NP), Octylphenol ethoxylates(OPE), Nonylphenol ethoxylates(NPE)
25. 2-(2'-Hydroxy-3',5'-di-tert-butylphenyl)benzotriazole
26. PFOA and its compounds, PFOS and its compounds, PFAS and its compounds
37. Perchlorate
38. Hexachlorobenzene
39. Mirex
40. Specified amine compounds
41. Benzene
42. Benzenamine, *N*-phenyl-, Reaction Products with Styrene and 2,4,4-Trimethylpentene (BNST)
43. Polyamide
44. PVDC (polyvinylidene chloride)
45. ESBO (Expoxidized soybean oil)
46. Formamide
47. Hexabromocyclododecane (HBCDD)
48. Red phosphorus
49. Aniline · formaldehyde polycondensate
50. Fluorescent powder
51. 4,4'-Sulfonyldiphenol (BPS)
52. Tris(1-chloro-2-propyl)phosphate (TCPP)
53. Tris(1,3-dichloro-2-propyl)phosphate (TDCPP)
54. Tris (2,3-dibromopropyl) phosphate
55. Tris (aziridiny) phosphin oxide
56. Tri-*o*-cresyl phosphate
57. Tris (2-chloroethyl) phosphate (TCEP)
58. Perfluorohexane-1-sulphonic acid and its salts (PFHxS)
59. Diisononyl phthalate (DINP)
60. Di-isodecyl phthalate (DIDP)
61. Di-*n*-octyl phthalate (DnOP)
62. Diethyl phthalate (DEP)
63. Dimethyl phthalate (DMP)
64. Cobalt
65. Mica
66. Graphite

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|-----------------------------------|---|
| 27. Bisphenol A                   | 67. Bis (2-ethylhexyl) phthalate (DEHP)             |
| 28. Formaldehyde                  | 68. Butyl benzyl phthalate (BBP)                    |
| 29. Dimethylfumarate (DMF)        | 69. Dibutyl phthalate (DBP)                         |
| 30. Triclosan                     | 70. Diisobutyl phthalate (DIBP)                     |
| 31. Nickel                        | 71. PIP (3:1) (phenol, isopropylated phosphate 3:1) |
| 32. REACH- Candidate List of SVHC | 72. DecaBDE (decabromodiphenyl ether)               |
| 33. Radioactive Substances        | 73. 2,4,6-TTBP (2,4,6-Tris(tert-butyl)phenol)       |
| 34. Natural Latex                 | 74. HCBd (hexachlorobutadiene)                      |
| 35. Dioxins and furans            | 75. PCTP (pentachlorothiophenol)                    |
| 36. Primary aromatic amines (PAA) |   |

With regard to composition of above grades of products, the aforesaid products comply with the Directives of RoHS (EU) 2015/863, 2011/65/EU, 2003/11/EC, TCO'07, Blue Angel and SONY Standard (SS-00259).

Sincerely Yours,



Perry D. B. Shiueh  
Vice President of R&D Division

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